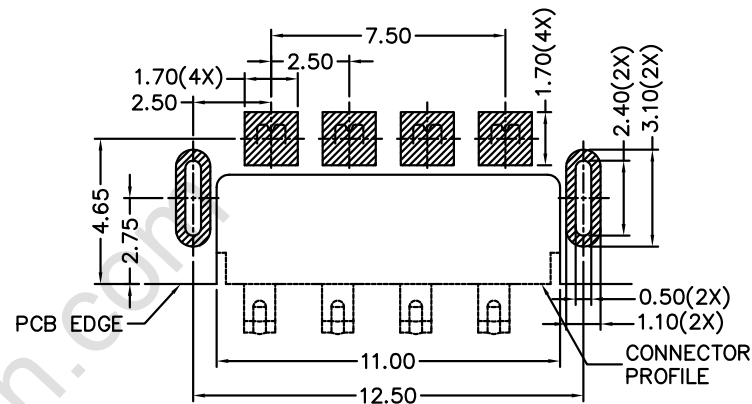
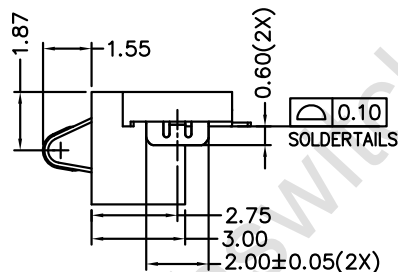
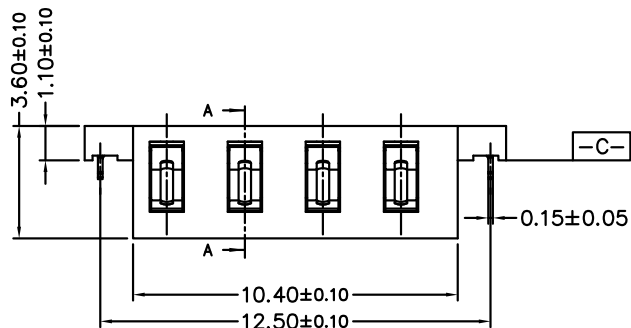
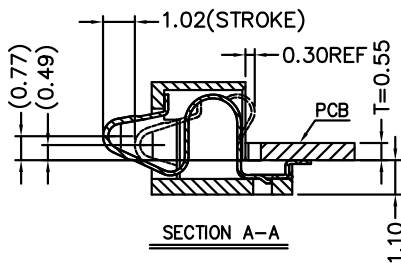
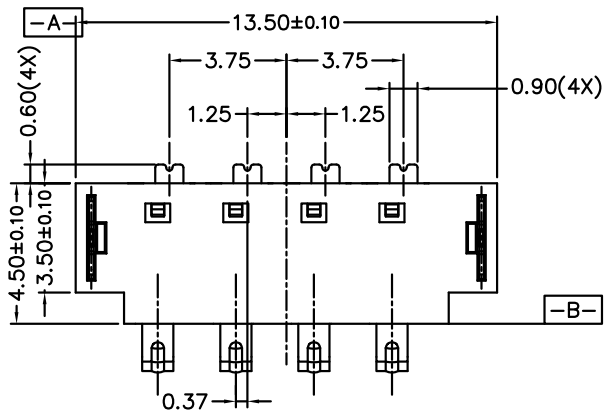




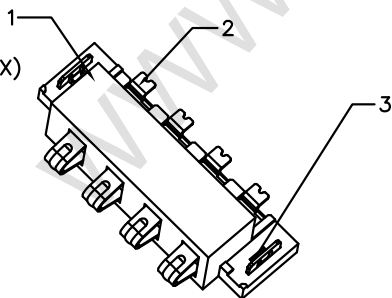
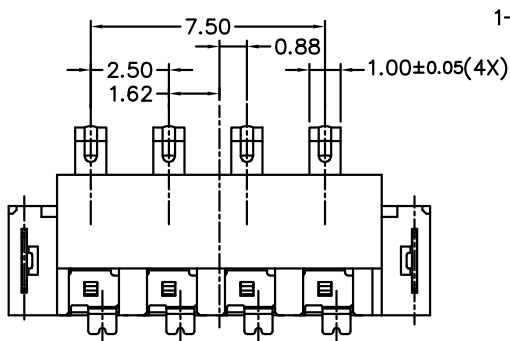
RECOMMENDED PCB LAYOUT
TOLERANCE IS ± 0.05

NOTES:

1. MATERIAL: SEE TABLE
2. FINISHED: SEE TABLE
3. SPECIFICATION:
 - 3.1 CURRENT RATING: 2.5A/DC MAX.
 - 3.2 VOLTAGE RATING: 12V/DC MAX.
 - 3.3 CONTACT RESISTANCE: 50MILLOHM MAX.
 - 3.4 DIELECTRIC WITHSTANDING VOLTAGE: 500 VAC T.M.S.
 - 3.5 INSULATION RESISTANCE: 500 MEGAOHMS MIN.
4. COMPLIANCE WITH HSP DIRECTIVE.
5. PRODUCT NO TWIST APPEARS AND MAXIMUM CUTTING BURR 0.10MM

QUALITY SYMBOLS

$\nabla=0$	$\nabla=0$	$\nabla=0$
MAJOR DIMENSION		
CRITICAL DIM (CPK CONTROL)		
CRITICAL DIM (SPC CONTROL)		



3	PAD	2	SUS304 THICKNESS=0.15mm.	OVER ALL: 50-80u"Ni ALL AREA: 80-120u"Tin
2	CONTACT	3	HIGH PERFORMANCE COPPER ALLOY THICKNESS=0.12mm.	OVER ALL: 80-120u"Ni CONTACT AREA: 3-5u"Au SOLDER AREA: GOLD FLASH
1	HOUSING	1	LCP UL 94V-0, BLACK	30% GLASS FILLED
ITEM	DESCRIPTION	QTY	MATERIAL	FINISH

DESIGN	MISS ZENG	SC ALL			TOLERANCE	ANGLES
DRAWING	MISS LI	ANIT	mm		X.XXX ± 0.15	± 5
CHECK	Mr. ZENG	SIZE	A4 : 210*297		X.XX ± 0.25	
APPROVAL		VERSION	01		X.X ± 0.38	

品名:

电池连接器

型号:

BHC25-3110400



东莞市航宏电子科技有限公司
Dongguan Hanghong Electronics Co., Ltd.